

SSC8033GS6A

P-Channel Enhancement Mode MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
201/	1201/	45mR@-10V	-4.5A
-30V	±20V	62mR@-4V5	

Description

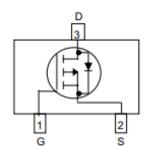
This P-Channel enhancement mode power FETs are produced with high cell density, DMOS trench technology, which is especially used to minimize on-state resistance. This device is particularly suited for low voltage application such as portable equipment, power management and other battery powered circuits and low in-line power loss are needed in a very small outline surface mount package.

Applications

- TFT panel power switch
- High side DC/DC Converter
- High side driver for brushless DC motor
- Portable DVD, DPF

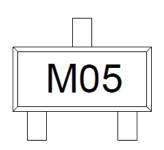
Pin configuration

Top view





SOT23-3L



Marking

> Ordering Information

Device	Package	Shipping
SSC8033GS6A	SOT23-3	3000/Reel



➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	-30	V
V_{GSS}	Gate-to-Source Voltage	±20	V
I _D	Continuous Drain Current ^a	-4.5	Α
I _{DM}	Pulsed Drain Current ^b	-16	Α
P _D	Power Dissipation ^c	1.5	W
P _{DSM}	Power Dissipation ^a	0.85	W
TJ	Operation junction temperature	-55 to 150	°C
T _{STG}	Storage temperature range	-55 to 150	°C

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a		150	°C/W
ReJC	Junction-to-Case Thermal Resistance		85	C/VV

Note:

- a. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A =25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t \leq 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

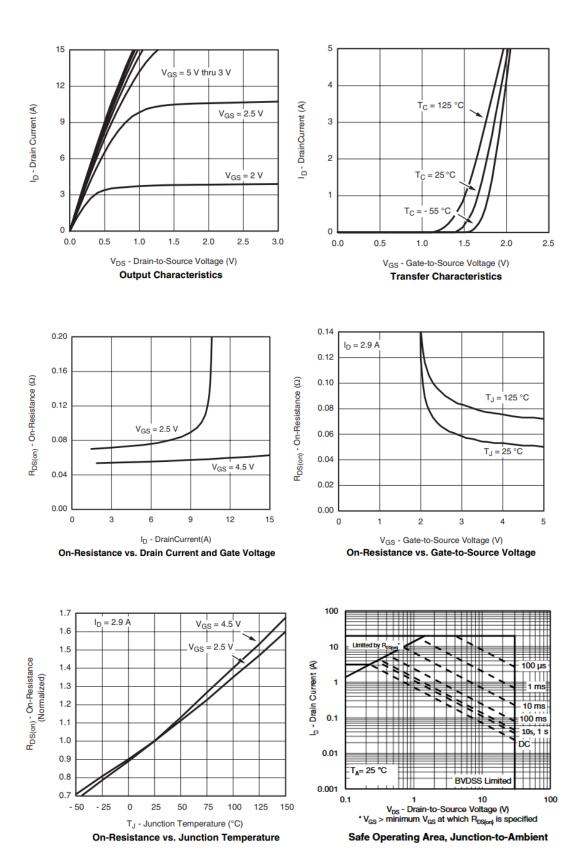


ightharpoonup **Electronics Characteristics**(T_A=25 $^{\circ}$ C unless otherwise noted)

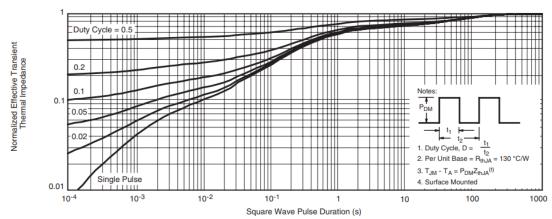
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V,ID=-250uA	-30			V
V _{GS} (th)	Gate Threshold Voltage	VDS=VGS,ID=-250uA	-1	-1.5	-2	V
Ь	Drain-Source On-	VGS=-10V,ID=-4.1A		45	70	mD
R _{DS(on)}	Resistance	VGS=-4.5V,ID=-3A		62	90	─ mR
I _{DSS}	Zero Gate Voltage Drain Current	VDS=-30V,VGS=0V			-1	uA
I _{GSS}	Gate-Source leak	VGS=±20V,VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=-5V,ID=-2.8A		6		S
V _{SD}	Forward Voltage	VGS=0V,IS=-0.75A		-0.8	-1.3	V
Ciss	Input Capacitance			680		
Coss	Output Capacitance	VDS=-6V, VGS=0V, F=1MHZ		72		pF
Crss	Reverse Transfer Capacitance			58		
T _{D(ON)}	Turn-on delay time	VGEN=-4.5V, VDS=-6V, RL=6R, RG=6R,ID=-1A		20		
Tr	Rise time			14		
T _{D(OFF)}	Turn-off delay time			65		ns
Tf	Fall time	,		21		



➤ Typical Characteristics(T_A=25°C unless otherwise noted)



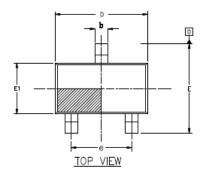


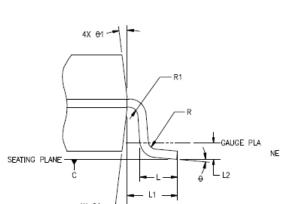


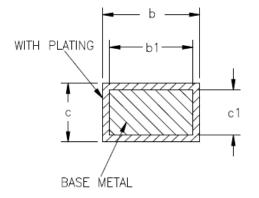
Normalized Thermal Transient Impedance, Junction-to-Ambient

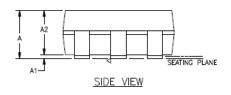


Package Information









SYMBOL	MIN	NOM	MAX
A			1.35
A1	0		0.15
A2	1.0	1.1	1.2
Ъ	0.35		0.45
ь1	0.32	-	0.38
с	0.14		0.20
c1	0.14	0.15	0.16
D	2.82	2.92	3.02
E	2.60	2.80	3.00
E1	1.526	1.626	1.726
е	1.8	1.9	2.0
L	0.35	0.45	0.6
L1	0.6REF		
L2	0.25REF		
R	0.1		
R1	0.1		
θ	0°	4°	8°
0 1	5°	10°	15°

NOTES: 1.All DIMENSIONS REFER TO JEDEC STANDARD

2.DIMENSION D DOES NOT INCLUDE MOLD FLASH
3.DIMENSION E1 DOSE NOT INCLUDE MOLD FLASH
4.FLASH OR PROTRUSION SHALL NOT EXCERD
0.25mm PER SIDE.

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